

who can benefit from the most innovative range of primers and lamination adhesives for HP Indigo label and packaging presses?

working for you.

you can.





SunEvo™ Primus LEP — Digital Coatings

Sales Information Sheet

Under the framework of a Solutions Partner Agreement, Sun Chemical is actively developing end-to-end solutions for HP Indigo presses with a strong focus on the label and packaging markets.

SunEvoTM Digital Coatings are collaborative initiative within the supply chain that aims to facilitate the evolution of digitally printed packaging and deliver improved workflows and technically advanced solutions that comply with industry standards. With SunEvo™ range of digital coatings, Sun Chemical can help customers in flexible packaging, labels, folding carton and corrugated, unleash the full power of digital printing.

SunEvoTM Digital Coatings range is structured around technological platforms involving the various digital printing techniques widely used today, including: electrophotography (EP), liquid electrophotography (LEP), water-based inkjet systems, energy curing inkjet systems, as well as other emerging digital printing techniques.

Whether your requirement is to promote adhesion, provide protection, add functionality or embellishment to your digitally printed packaging application, Sun Chemical is your perfect partner.

SunEvoTM Primus LEP is a water-based primer composition for Shrink Sleeves and Flexible Packaging printed with HP Indigo presses which allows for direct seaming while providing suitable bonds for shrink sleeve tunnel application, and eliminating the need for lane priming, simplifying operations and increasing productivity.

Primers										
Application	Family	Reference	Description	Substrate						
Sleeves and Flexible Packaging	Primus LEP	FCDEV318	SEAMABLE PRIMER	PETg, BOPP						

SunLam[™] is a comprehensive range of solvent-based, solventless, water-based and migration-compliant lamination adhesives suitable for HP Indigo printed packaging applications.

Lamination Adhesives									
Application	Family	Reference	Technology	Dry Food	Liquids	Boil-in-a- bag	Retort	Substrate	
Flexible Packaging	SunLam™	WB300 + WB 800	WB	•	•			PET/PE, OPP/OPP, OPP/CPP, OPP/metallized OPP, PET/AL-PE	
	SunLam™	NS2100A + HA221B	SL	•	•			PET/PE, OPP/OPP, OPP/PE, OPP/CPP	
	SunLam™	NS21A + HA105B	SL	•	•	•		OPP/OPP, OPP/metallized OPP, PET/PE, PET/AL-PE	
	SunLam™	ZA-1000 + ZB-301	SL	•	•			OPP/CPP, OPP/OPP, OPP/metallized PET, PET/metallized OPP, PET/LLDPE, OPA/LDPE, PET/ALU/PE, Barrier laminates	
	SunLam™	LX-415A + SP75	SB	•		•		OPP/CPP, OPP/OPP, PET/CPP, PET/LLDPE, OPA/LLDPE	
	SunLam™	LX-545 + IP-70	SB			•	•	PET/CPP, PET/AL/CPP, PET/AL/OPA/CPP, PET-SiOx/CPP, PET-AIOx/CPP, OPA/CPP, PET/AL/LDPE	

 $WB = Water, SB = Solvent\ Based,\ SL = Solventless$



To find out more about SunEvo™ Digital Coatings and its most comprehensive and technically advanced range of primers, adhesives and over print varnishes, visit www.sunchemical.com/SunEvo.

Our Products are intended for sale to professional users. The information herein is general information designed to assist customers in determining the suitability of our products for their applications. All recommendations are made without guarantee, since the application and conditions of use are beyond our control. We recommend that customers satisfy themselves that each product meets their requirements in all respects before commencing a print run There is no implied warranty of merchantability or fitness for purpose of the product or products described herein. In no event shall Sun Chemical be liable for damages of any nature arising out of the use or reliance upon this information. Modifications of the product for reasons of improvements might be made without further notice.

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